Quad Analog Switches/Quad Multiplexers

HITACHI

Description

This switch has low "on" resistance and low "off" leakage. It is a bidirectional switch, thus any analog input may be used as an output and vice-versa. Also the HD74HC4066 switch contains linearization circuitry which lowers the "on" resistance and increases switch linearity. The HD74HC4066 device allows control of up to 12 V (peak) analog signals with digital control signals of the same range. Each switch has its own control input which disables each switch when low.

Features

- High Speed Operation
- Wide Operating Voltage
- Low Quiescent Supply Current

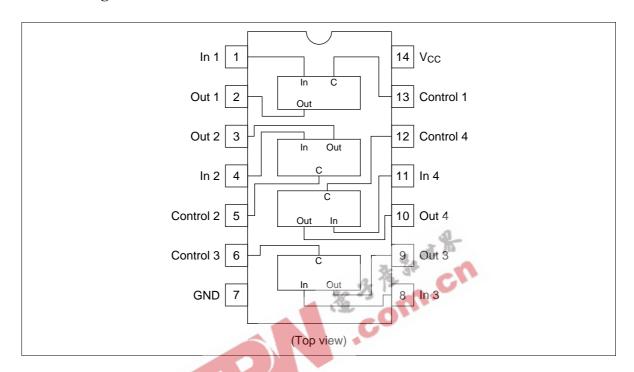
Function Table

Control	Switch
L	OFF
Н	ON

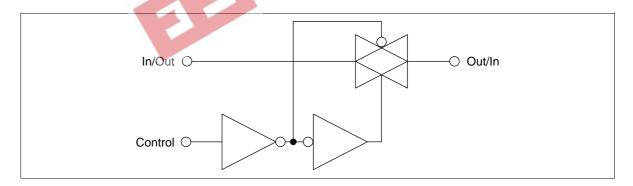
 $\begin{aligned} & \mathsf{GND} \leq \mathsf{Vin} \leq \mathsf{V}_{\mathsf{CC}} \\ & \mathsf{GND} \leq \mathsf{Vout} \leq \mathsf{V}_{\mathsf{CC}} \end{aligned}$



Pin Arrangement



Logic Diagram (1/4)



Absolute Maximum Ratings

Item		Symbol	Rating	Unit
Supply voltage		V _{cc}	-0.5 to +7.0	V
Control input voltage		V _{IN}	-0.5 to V_{cc} + 0.5	V
Switch I/O voltage		V _{I/O}	-0.5 to V_{cc} + 0.5	V
Supply current	(V _{CC})	I _{cc}	+50	mA
	(GND)	I_{GND}	-50	mA
Switch I/O current (per pin)		I _{I/O}	±25	mA
Control input diode current		I _{IK}	±20	mA
Switch I/O diode current		I _{IOK}	±20	mA
Power dissipation		P _T	500	mW
Storage temperature range		Tstg	-65 to +150	°C
			-65 to +150	



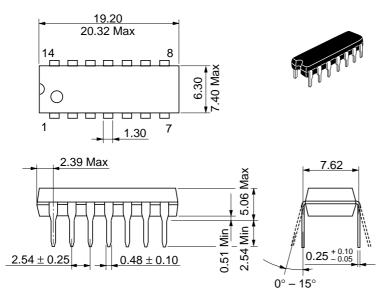
DC Characteristics

			Ta = 2	25°C		Ta = - +85°0	-40 to		
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Control input voltage	V _{IH}	2.0	1.5	_	_	1.5	_	V	
		4.5	3.15	_	_	3.15	_		
		6.0	4.2	_	_	4.2	_		
	V _{IL}	2.0	_	_	0.5	_	0.5	V	
		4.5	_	_	1.35	_	1.35		
		6.0	_	_	1.8	_	1.8	_	
"ON" resistance	R _{on}	2.0	_	2000	5000	_	6250	Ω	$V_{C} = V_{IH}$
		4.5	_	100	200	_	250	4	$Vin = 0 \text{ to } V_{CC}$
		6.0	_	60	170	_	210	, Ju	lin/out = 1 mA
ΔON resistance	ΔR_{ON}	2.0	_	50	_	一卷	34	Ω	$V_{\rm C} = V_{\rm IH}$, lin/out = 1 mA
between any two		4.5	_	3	26	77	A)		between any two
channels		6.0	_	2	-	- 0	7.	_	channels
OFF channel leakage current	I _{S (OFF)}	6.0	M	7	±0.1		±1.0	μΑ	$V_{C} = V_{IL}$ $V_{IN} = V_{CC}$, $Vout = GND$
(switch off)									or, $Vin = GND$, $Vout = V_{CC}$
OFF channel leakage current (switch on)	I _{s (ON)}	6.0		_	±0.1	_	±1.0	μΑ	$V_{C} = V_{IH}$ Vin = V_{CC} or GND
Control input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	Vin = V _{CC} or GND
Quiescent supply current	I _{cc}	6.0	_	_	1.0	_	10.0	μΑ	Vin = V _{CC} or GND

AC Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

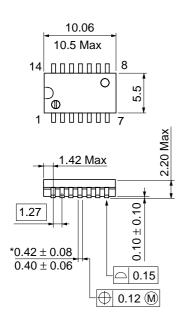
			Ta = :	25°C		Ta = +85°(–40 to C		
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Propagation delay	t _{PLH}	2.0	_	_	50	_	65	ns	$R_L = 10 \text{ k}\Omega$
time	$t_{\scriptscriptstylePHT}$	4.5	_	4	10	_	13	_	
		6.0	_	_	9	_	11		
Output enable	\mathbf{t}_{ZH}	2.0	_	_	115	_	145	ns	$R_L = 1 \text{ k}\Omega$
time		4.5	_	10	23	_	29	_	
		6.0	_	_	20	_	25	_	
Output disable	\mathbf{t}_{LZ}	2.0	_	_	115	_	145	ns	$R_L = 1 \text{ k}\Omega$
time	\mathbf{t}_{HZ}	4.5	_	14	23	_	29	2	
		6.0	_	_	20	_	25	L /D	
Sine wave distortion		4.5	_	0.05	90	方符	30	%	$R_L = 10 \text{ k}\Omega, C_L = 50 \text{ pF},$ $f_{IN} = 1 \text{ kHz}$
Band width (-3 dB)		4.5	_	30	CIL	CC	D.	MHz	$R_{L} = 600 \Omega, C_{L} = 50 pF,$ 20 log ₁₀ Vout/Vin = -3dB
Feedthrouth attenuation		4.5		-50	- '	_	_	dB	$R_{L} = 600 \Omega, C_{L} = 50 pF,$ $f_{IN} = 1 MHz$
Cross talk between		2.0		25	_	_	_	mΑ	$R_L = 600 \Omega$, $C_L = 50 pF$,
control input to	1	4.5		60	_	_	_		$f_{IN} = 1 \text{ MHz}$
signal I/O		6.0	_	75	_	_	_		
Cross talk between any two switches		4.5	_	-50	_	_	_	dB	$R_{L} = 600 \Omega, C_{L} = 50 pF,$ $f_{IN} = 1 MHz$
Maximum control		2.0	_	20	_	_	_	MHz	$R_L = 1 \text{ k}\Omega, C_L = 15 \text{ pF},$
frequency		4.5	_	30	_	_	_		$Vout = 1/2 (V_{cc})$
		6.0	_	30	_		_		
Control input capacitance	Cin		_	5	10	_	10	pF	
Switch I/O capacitance	Cin/out		_	6	_	_	_	pF	
Feed through capacitance	Cin/out		_	0.5	_	_	_	pF	
Power dissipation capacitance	C _{PD}		_	13	_	_		pF	

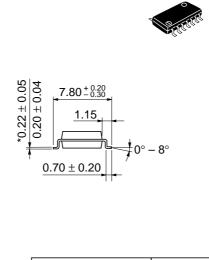




Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g



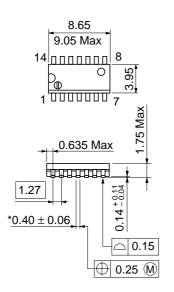


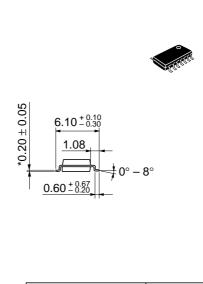


Hitachi Code	FP-14DA
JEDEC	_
EIAJ	Conforms
Weight (reference value)	0.23 g

*Dimension including the plating thickness
Base material dimension

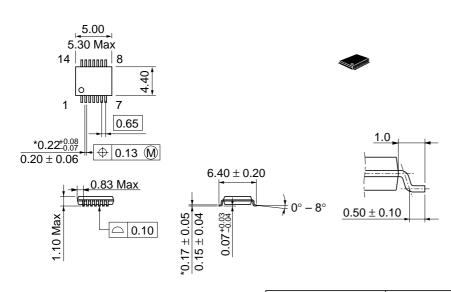






Hitachi Code	FP-14DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.13 g





Hitachi Code	TTP-14D
JEDEC	
EIAJ	
Weight (reference value)	0.05 g

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